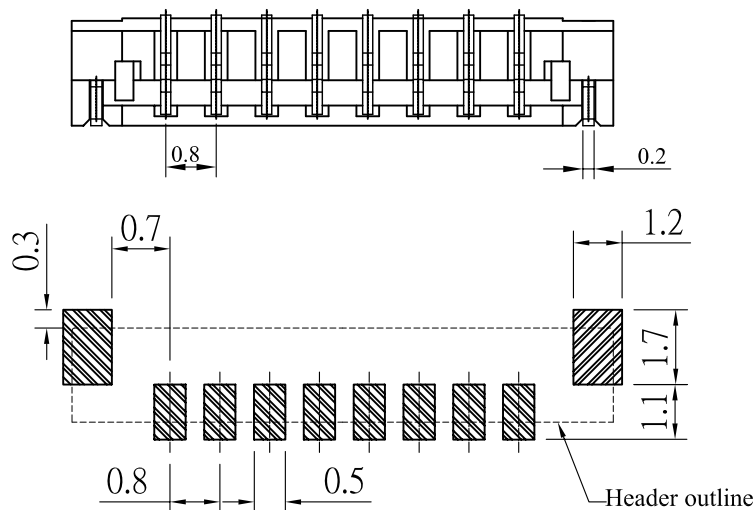
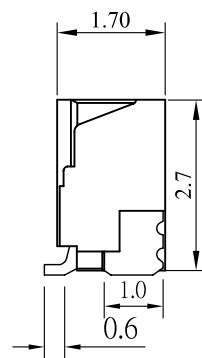
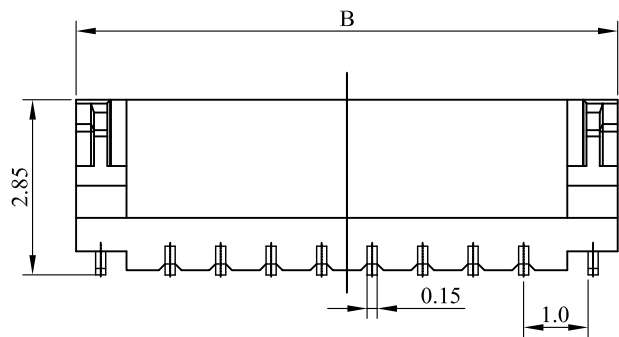
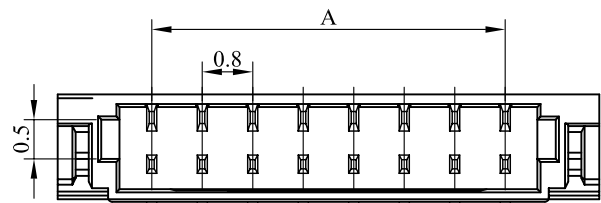




RECOMMENDED P.C. BOARD PATTERN DIM.

Specifications

Electrical

Voltage Rating: 30V(DC)

Current Rating: 0.5A AC DC

Contact Resistance: 20m Ω max

Dielectric Withstandeing Voltage: 200V AC/1min.

Insulation Resistance: 100M Ω min

Temperature Range: -25°~+85°

Material

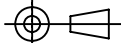
Circuits: 2~20

Insulator: Polyamide UL 94V-0

Pin: Phosphor Bronze/Tin-Plated

Solder tad: Brass, copper-undercoated,
tin/lead-plated

Poles	Part No.	Dimension mm (in.)	
		A	B
2	080G1-MV02	0.8(.031)	3.8(.150)
4	080G1-MV04	2.4(.094)	5.4(.213)
6	080G1-MV06	4.0(.157)	7.0(.275)
7	080G1-MV07	4.8(.177)	7.8(.307)
8	080G1-MV08	5.6(.220)	8.6(.339)
9	080G1-MV09	6.4(.252)	9.4(.370)
10	080G1-MV10	7.2(.283)	10.2(.401)
12	080G1-MV12	8.8(.346)	11.8(.464)
14	080G1-MV14	10.4(.409)	13.4(.528)
15	080G1-MV15	11.2(.441)	14.2(.559)
16	080G1-MV16	12.0(.472)	15.0(.591)
17	080G1-MV17	12.8(.504)	15.8(.622)
20	080G1-MV20	15.2(.598)	18.2(.717)

Rev	Description/Date	Drawn By: Storm.li	Customer:	Third angle projection 		Units: mm	
		Checked By: Simmon	Part No.: 080G1-MVXX	General Dimension Tolerance		TOLERANCE X.XX±0.15 X.X ±0.25	ANGLE TOLERANCE±2°
		Approved By: Tony				SCALE 2:1	
SGS Report No.:			Title:	0.8mm Wire to Board Wafer SMT 180°			